Taiwan Semiconductor

1A, 200V - 600V Surface Mount Super Fast Rectifier

FEATURES

- Glass passivated junction chip
- Ideal for automated placement
- Low profile package
- Low power loss, high efficiency
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- High frequency rectification
- Freewheeling application
- Switching mode converters and inverters in computer, automotive and telecommunication.

MECHANICAL DATA

- Case: SOD-123FL
- Molding compound meets UL 94 V-0 flammability rating
- Moisture sensitivity level: level 1, per J-STD-020
- Packing code with suffix "G" means green compound (halogen-free)
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 1A whisker test
- Polarity: As marked
- Weight: 16 mg (approximately)

KEY PARAMETERS		
PARAMETER	VALUE	UNIT
I _{F(AV)}	1	А
V _{RRM}	200 - 600	V
I _{FSM}	30	А
T _{J MAX}	150	°C
Package	SOD-123FL	
Configuration	Single dice	





SOD-123FL

ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)					
PARAMETER	SYMBOL	ES1DFL	ES1GFL	ES1JFL	UNIT
Marking code on the device		EDF	EGF	EJF	
Repetitive peak reverse voltage	V _{RRM}	200	400	600	V
Reverse voltage, total rms value	V _{RMS}	140	280	420	V
Maximum DC blocking voltage	V _{DC}	200	400	600	
Forward current	I _{F(AV)}		1		А
Surge peak forward current, 8.3 ms single half sine- wave superimposed on rated load per diode	I _{FSM}	30		А	
Junction temperature	TJ		- 55 to +150)	°C
Storage temperature	T _{STG}	- 55 to +150		°C	





THERMAL PERFORMANCE				
PARAMETER	SYMBOL	ТҮР	UNIT	
Junction to Lead Thermal Resistance	R _{ejl}	35	°C/W	
Junction to Ambient Thermal Resistance	R _{eJA}	85	°C/W	

ELECTRICAL SPEC	CIFICATION	S (T _A = 25°C unless ot	nerwise noted)			
PARAMETER		CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
Forward voltage ⁽¹⁾	ES1DFL	I _F = 1A, T _J = 25°C	V _F	-	1.0	V
	ES1GFL			-	1.3	V
	ES1JFL			-	1.7	V
Reverse current @ rated V _R per diode ⁽²⁾		$T_J = 25^{\circ}C$	I _R	-	5	μA
		T _J = 125°C		-	100	μA
Junction capacitance		1 MHz, V _R =4V	CJ	8	-	pF
Reverse recovery time		I _F =0.5A , I _R =1.0A I _{RR} =0.25A	t _{rr}	-	35	nS

Notes:

- 1. Pulse test with PW=0.3 ms
- 2. Pulse test with PW=30 ms

ORDERING INFORMATION				
PART NO.	PACKING CODE	PACKING CODE SUFFIX	PACKAGE	PACKING
ES1xFL	RV	0	SOD-123FL	3,000 / 7" Plastic reel
(Note1)	RQ	G	SOD-123FL	10,000 / 13" Paper reel

Notes:

- 1. "x" defines voltage from 200V (ES1DFL) to 600V (ES1JFL)
- 2. Whole series with green compound

EXAMPLE				
EXAMPLE P/N	PART NO.	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION
ES1JFL RVG	ES1JFL	RV	G	Green compound



CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

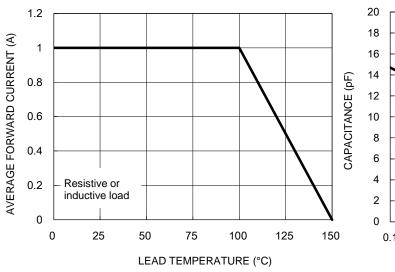


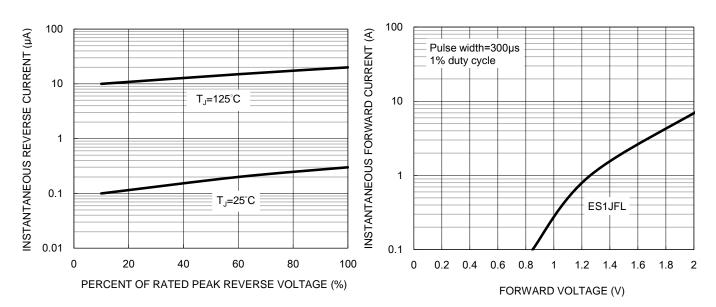
Fig1. Forward Current Derating Curve

20 18 16 14 12 10 8 6 4 2 0.1 1 10 10 REVERSE VOLTAGE (V)

Fig2. Typical Junction Capacitance

Fig3. Typical Reverse Characteristics

Fig4. Typical Forward Characteristics





CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig5. Maximum Non-repetitive Forward Surge Current

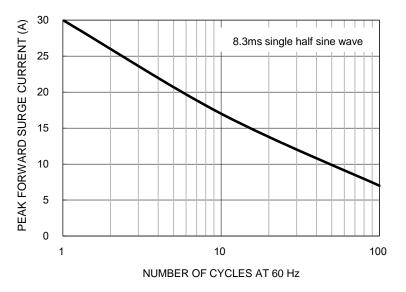
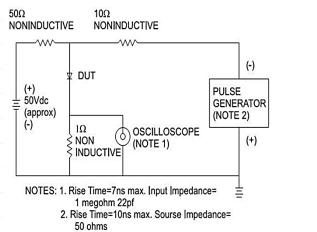
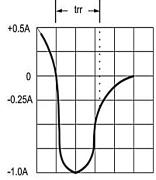


Fig6. Reverse Recovery Time Characteristic And Test Circuit Diagram



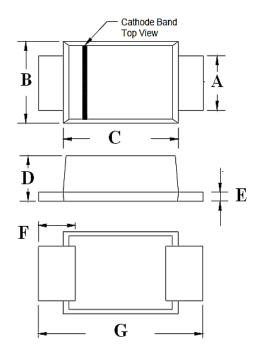


Version:C1812



PACKAGE OUTLINE DIMENSIONS

SOD-123FL



DIM	Unit (mm)		Unit (inch)	
DIM.	Min	Max	Min	Max
А	0.80	1.15	0.031	0.045
В	1.70	2.10	0.067	0.083
С	2.60	3.10	0.102	0.122
D	0.88	1.35	0.035	0.053
Е	0.10	0.30	0.004	0.012
F	0.30	0.90	0.012	0.035
G	3.45	3.95	0.136	0.156

MARKING DIAGRAM



P/N	= Marking Code
YW	= Date Code

F = Factory Code



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